APPROVAL SHEET

(承認仕様書)

REMARK	(a) type		
APPLICATION			
M O D E L	DSC-8D-15MSFC(DC5)		
ΙΤΕΜ	NTC THERMISTOR		
CUSTOMER			

DSC ELECTRONICS CO., LTD.

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SPECIFICATION FOR NTC THERMISTOR

IN-RUSH CURRENT LIMITER : 15 PIE

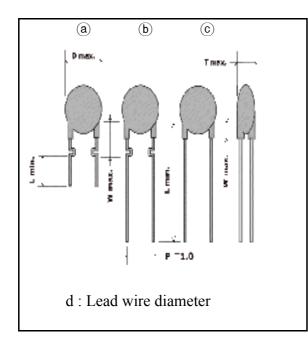
1. APPLICATIONS

- 1) INRUSH CURRENT LIMITING IN PERIPHERAL COMMUNICATION EQUIPMENT, MONITORS, PCs, SMPS.
- 2) SOFT-START MOTORS, e.g. IN VACUUM CLEANERS
- 3) CIRCUIT APPLICATIONS REQUIRING HIGH CONTINUOUS CURRENTS
- 4) USEABLE IN SERIES CONNECTION UP TO 250 Vrms

2. FEATURES

- 1) HIGH RELIABILITY AND MINIMIZED AGE DRIFT, LOW-COST AND WIDE APPLICATIONS
- 2) BLACK SILICONE OR EPOXY COATED THERMISTOR DISK
- 3) STRAIGHT OR IN/OUT KINKED OR CUTTED LEADS OF TINNED, NICKEL PLATED COPPER WIRE
- 4) USEABLE IN SERIES CONNECTIONS UP TO MAX. 260Vrms (STEADY STATE 240Vrms)
- 5) AVAILABLE ON TAPE
- 6) RESISTANCE TOLERANCE <±20% AVAILABLE UPON REQUEST
- 7) U.L. APPROVAL

3 DIMENSION



	a	b	C
D (MAX.)	16.5	16.5	16.5
T (MAX.)	6	6	6
Р	7.5	7.5	7.5
W (MAX.)	8	8	6
L (MIN.)	5±1	25	25
d	ф 0.8	ф0.8	ф0.8
WIRE FORM	F/C	F	S

4. ELECTRICAL CHARACTERISTICS

- 1) ZERO POWER RESISTANCE AT 25 $^{\circ}$ C (Ohms) :
- 2) MAX STEADY STATE CURRENT (Amps)
- 3) THERMAL DISSIPATION CONSTANT (mW/C) : REFERENCE No. 5

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- 4) THERMAL TIME CONSTANT (sec)
- 5) OPERATING TEMPERATURE ($^{\circ}$ C)
- 6) B VALUE (25/85°C)

(UNIT:mm)

SPECIFICATION FOR NTC THERMISTOR					
5. SPECIFICATIO	5. SPECIFICATIONS OF SIMILAR SIZE				
TYPE No.	NORMAL RESISTANCE AT 25℃ (ohms/Ω)	MAX. STEADY STATE CURRENT (amps/A)	THERMAL DISSIPATION CONSTANT (mW/℃)	THERMAL TIME CONSTANT (sec)	NORMAL B CONSTANT (25/85℃,K)
DSC - 1D – 15	1.0	7.5	22	62	2850±5%
DSC - 2.5D – 15	2.5	7.0	21	63	2900
DSC - 3D – 15	3.0	6.7	21	70	2900
DSC - 5D – 15	5.0	6.0	20	75	3000
DSC - 7D – 15	7.0	6.0	20	76	3000
DSC - 8D – 15	8.0	5.5	20	78	3100
DSC - 10D – 15	10.0	5.0	19	80	3150
DSC - 12D – 15	12.0	4.8	18	82	3150
DSC - 15D – 15	15.0	4.5	17	86	3180
DSC - 16D – 15	16.0	4.0	17	87	3200
DSC - 20D – 15	20.0	3.0	15	90	3250
DSC - 25D – 15	25.0	2.8	15	90	3250
DSC - 30D –15	30.0	2.5	16	95	3300

* Resistance tolerance :±10, 15, 20%

6. MATERIAL LIST

ITEM	MATERIAL	DESCRIPTION	WEIGHT(g)	HAZARDOUS SUBSTANCE
	Mn3O4	POWDER99.9%		CONTAIN (PPM)
	Co3O4	POWDER99.9%		Pb
Element	NiO	POWDER99.9%	1.53	Cd
	CuO	POWDER99.9%		Hg
	Ag PASTE	CON COAT.		Cr+6
Lead wire	Cu / Sn	0.8 pie	0.17	PBBs
Solder	Sn×Ag	96.5 / 3.5	0.45	PBDs
Coating	SILICONE COAT.	OHMCOAT AF490	0.40	

7. TERMINOLGY AND GENERAL SPECIFICATIONS

TECHNICAL TERMS	DESCRIPTIONS	SPEC.
OPERATING TEMP.	OPERATING TEMPERATURE RANGE WITHOUT DERATING	-40 TO 180 ℃
STORAGE TEMP	STORAGE TEMPERATURE RANGE WITHOUT CURRENT APPLIED.	-30 TO 80 °C
ZERO POWER RESISTANCE	THE ZERO POWER RESISTANCE IS THE RESISTANCE OF A THERMISTOR AT 25℃ AMBIENT TEMPERATURE.	SEE RATING TABLE
B VALUE	B VALUE CAN BE DERIVED BY MEASURING THE RESISTANCE AT 25 °C (R1) AND85 °C (R2) AND CALCULATING BY FOLLOWING FORMULA. B= $\frac{\text{Ln}(\text{R2/R1})}{1/(273.15+\text{T2})-1/(273.15+\text{T1})}$	SEE RATING TABLE
MAX. STEADY STATE CURRENT	THE MAX STEADY STATE CURRENT IS THE MAXIMUM ALLOWABLE CURRENT AT LOADING TO MAX OPERATING TEMPERATURE IN 25℃ AMBIENT.	SEE RATING TABLE
THERMAL DISSIPATION CONSTANT	THE DISSIPATION CONSTANT MEANS THE AMOUNT OF POWER REQUIRED TO RAISE THE APPLIED TEMPERA- TURE TO THE THERMISTOR IN STATIONARY STATE FOR 1℃.	SEE RATING TABLE
THERMAL TIME CONSTANT	THE TIME CONSTANT IS DEFINED AS RELATIONSHIP BETWEEN THE THERMAL CAPACITY AND DISSIPATION CONSTANT. IT IS MEASURED AS TIME IN SECONDS WITCH IS NEEDED FOR THERMISTOR TEMPERATURE CHANGE DF 63.2% DIFFERENCE BETWEEN INITIAL AND FINAL THERMISTOR TEMPERATURE.	SEE RATING TABLE

D S C

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TECHNICAL TERMS	DESCRIPTIONS	SPEC.
LOAD LIFE	THERMISTOR SHALL BE STORED FOR	MAXIMUM
	1,000± 12HOURS AT 25 ℃ ± 2 ℃ WITH	RESISTANCE
	THE MAXIMUM RATED APPLICABLE	CHANGE :
	STEADY STATE CURRENT APPLIED.	± 15% OF
	AFTER THE STORAGE PERIOD.	INITIAL
	TO AND STABILIZED AT ROOM TEMP.	
		MAXIMUM
		RESISTANCE
	THERMISTOR SHALL BE SUBJECTED TO	CHANGE :
	THE FOLLOWING 10 CYCLES :	± 15% OF
	AT -40±3℃ FOR 30 MINUTES AND	INITIAL, AND
TEMPERATURE	AT +150 ± 2 °C FOR 30 MINUTES.	THERE SHALL
CYCLE	AFTER THE CYCLES. THE THERMISTOR	BE NO
	SHALL BE RETURNED TO AND STABILIZED	EVIDENCE
	AT ROOM AMBIENT TEMP.	OF HARMFUL
		CORROSION,
		MECHANICAL
MOISTURE	THERMISTOR SHALL BE STORED FOR	MAXIMUM
RESISTANCE	1,000 ±12 HOURS AT 40±2℃, 90-95% RH	RESISTANCE
	WITH NO CURRENT APPLIED. AFTER THE	CHANGE :
	STORAGE PERIOD THE THERMISTOR	± 15% OF
	SHALL BE RETURNED TO AND STABILIZED	INITIAL.
	AT ROOM TEMP.	
LEAD FULL	AFTER GRADUALLY APPLYING THE 1Kg	
STRENGTH	LOAD AND KEEPING THE UNIT FIXED	NO
	FOR 10 SECONDS IN THE AXIAL	OUTSTANDING
	DIRECTION.	DAMAGE.
	THE LEAD SHALL BE VISUALLY EXAMINED	
	FOR ANY DAMAGE	
SOLDERING HEAT	THE LEAD WIRE OF THE THERMISTOR	MAXIMUM
RESISTANCE	SHALL BE DIPPED WITH 4±1mm SPACE	RESISTANCE
	OF 300± 5℃ FOR 3 SEC, RETURNED	CHANGE :
	TO AND STABILIZED AT ROOM TEMP.	± 15% OF
		INITIAL.

D S C

		DSC
TECHNICAL TERMS	DESCRIPTIONS	SPEC.
SOLDERABILITY	WHEN THE LEAD WIRE OF THERMISTOR WAS DIPPED INTO SOLDER (Sn96.5Ag3.5) BATH of 330± 5℃ FOR 3 SECONDS AFTER IMMERSION IN 25%RESIN FLUX THE SOLDERABILITY RATIO OF LEAD WIRE SURFACE SHOULD BE MORE THAN 95%	MORE THAN 95% SOLDERABILITY
SURGE CURRENT LIFE	THERMISTOR SHALL BE SUBJECTED THE FOLLOWING 2,000 CYCLES. - SURGE CURRENT : MAX STEADY STATE CURRENT -NTERVAL : 15 SECONDS AFTER THE CYCLES, THE THERMISTOR SHALL BE RETURNED TO.	MAXIMUM RESISTANCE CHANGE : ± 15%
INSULATION RESISTANCE	THE THERMISTOR SHOULD BE NO CHANGED. AFTER APPLIED THE VOLTAGE OF 1,500 Vac FOR ONE MINUTE BETWEEN THE LEAD WIRE AND THE INSULATION COATED PORTION.	WITHIN ± 15% RESISTANCE CHANGE AND NO DAMAGE.
INSULATION RESISTANCE	THE INSULATION RESISTANCE SHOULD BE OVER 500M OHMS WITH 1,000Vdc BETWEEN THE LEAD WIRE AND THE INSULATION COATED PORTION.	WITHIN±15% RESISTANCE CHANGE AND NO DAMAGE.
MODEL NUMBERING		DF ELEMENT
	± 15% E/S : EPOXY/STRAI : ± 20% S/S : SILICONE/STR	GHT AIGHT
B :	S/F : SILICONE/FOF BULK CUTTING	CMING

